

SID

Factory: Rot am See

Article:

694

ML10

Provided:

Stockburger, Olesja

Customer:

Date:

01.02.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	220		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		18	L2	
A-RS-FR4-ML-0.51mm-018+018-TG150-HF	50200855	510		
		18	L3	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	120		
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		
		18	L4	
A-RS-FR4-ML-0.51mm-018+018-TG150-HF	50200855	510		
		18	L5	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	210		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		18	L6	
A-RS-FR4-ML-0.51mm-018+018-TG150-HF	50200855	510		
		18	L7	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	120		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		18	L8	
A-RS-FR4-ML-0.51mm-018+018-TG150-HF	50200855	510		
		18	L9	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	220		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	

Thickness after Pressing

B00:

3090 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3410 µm

Dmin:

2770 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

3200 µm

Tol+:

320 µm

Tol-:

320 µm

Dmax:

3520 µm

Dmin:

2880 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

3110 µm

Version 1.2.14.15

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